NUMBER GS-20-0362	Application Specification	Amphenol FC		
TITLE Application Guide for PwrLoPro H	leaders and Receptacles	PAGE REVISION 1 of 22 C AUTHORIZED BY DATE Fancy Zhang 20- Apr-		
			CTED	

1. OBJECTIVE

This specification provides information and requirements regarding customer application of PwrLoPro Connector System. This specification is intended to provide general guidance for application process development. It is recognized that no single application process will work under all customer scenarios and that customers will develop their own application processes to meet their needs. However, if these application processes differ greatly from the one recommended, FCI cannot guarantee results.

2. SCOPE

This specification provides information and requirements regarding customer application of PwrLoPro Connector System. The product possibilities for configuration including:

- Right angle headers
- Right angle receptacles
- Vertical receptacles

3. GENERAL

- 3.1. This document is meant to be an application guide. If there is a conflict between the product drawings and specifications, the drawings take precedence.
- 3.2. All numerical values are in metric units. Dimensions are in millimeters. Unless otherwise specified, dimensions have a tolerance of ±0.13mm and angles have a tolerance of ±2°. Figures and illustrations are for identification only and are not drawn to scale.

NUMBER	TYPE			
GS-20-0362	Application Specification	Amphenol FC		
TITLE		PAGE	REVISION	
		2 of 22	С	
Application Guide for PwrLoPro H	oplication Guide for PwrLoPro Headers and Receptacles		DATE	
		Fancy Zhang	20- Apr-2016	

3.3. This document covers the following sections:

<u>Para</u>	Paragraph <u>Title</u>		<u>Page</u>
1.		Objective	1
2.		Scope	1
3.		General	1
4.		Drawings and Applicable documents	3
5.		Introduction	3
6.		Requirements	4
	6.1	Safety	5
	6.2	Limitations	5
	6.3	Material	6
	6.4	Storage	6
	6.5	PCB Board	6
	6.6	Connector Placement	8
	6.7	Mounting Hardware	8
	6.8	Soldering	9
	6.9	Connector Mating	10
	6.10	Checking Installed Connector	12
	6.11	Connector Mating	13
	6.12	Circuit Testing	17
	6.13	Connector Removal	18
	6.14	Repair	18
7.		Qualification	18
8.		Tooling	18
9. 10. 11.		Visual Aid Product Part Number Assignments Record Retention	19 20 21

NUMBER GS-20-0362	TYPE Application Specification	Amphen	ol FCi
Application Guide for PwrLoPro H	eaders and Receptacles	PAGE REVISION 3 of 22 C AUTHORIZED BY DATE Fancy Zhang 20- Apr-2	
<u></u>			TED

4. DRAWINGS AND APPLICABLE DOCUMENTS

- FCI PRODUCT SPECIFICATION GS-12-1064
- FCI PRODUCT DRAWINGS

Product drawings and **FCI's GS-12-1064** Product Specification are available at <u>www.fci.com</u> In the event of a conflict between this application specification and the drawing, the drawing will take precedence. Customers are advised to refer to the latest revision level of FCI product drawings for appropriate details.

5. INTRODUCTION

5.1. This specification covers the requirements for PwrLoPro connectors onto printed circuit (pc) boards specifically designed for module hot-swappable power distribution systems. These connectors consist of right-angle header assemblies, right-angle-receptacle assemblies and vertical-receptacle assemblies. PwrLoPro have precision formed compliant pin contacts that can be used either for press-fit application or wave soldering application. Each connector consists of one housing with power modules containing one row of power (either header or receptacle) contacts and signal modules containing 5 rows of signal (either header or receptacle) contacts. When corresponding with personnel, use the terminology provided in this specification to facilitate your inquiries for information.

Basic terms and features of this product are provided in Figure 1.

NUMBER GS-20-0362	Application Specification	Amphenol FCi		
TITLE Application Guide for PwrLoPro H	eaders and Receptacles	PAGE REVISION 4 of 22 C AUTHORIZED BY Fancy Zhang 20- Apr-2		

Right-Angle Header Assembly (25S X 10P, Ref)



Right-Angle Receptacle Assembly (25S X 10P, Ref)







5.2. PCB Alignment

5.2.1. Right Angle Receptacle to Right Angle Header



NUMBER	TYPE			
GS-20-0362	Application Specification	Amphenol FC		
TITLE		PAGE	REVISION	
		6 of 22	С	
Application Guide for PwrLoPro Headers and Receptacles		DATE		
		Fancy Zhang	20- Apr-2016	

5.2.2. Vertical Receptacle to Right Angle Header



Figure 1b

- 5.3. The connectors are available in two contact mating lengths to provide 2 levels of mating sequence : the power contact Level 1: mate-first break-last(MFBL) and LEVEL 2: standard, and the signal contacts have Level 2 : standard and Level 3 : mate-last break-first (MLBF). Each power module has a contact centerline spacing of 2.75mm. Each signal module has a contact centerline spacing of 2.00mm.
- 5.4. Each housing has an embossed dot to indicate the NO.1 circuit. The maximum overall length allowed for the connector is 101mm. Thirty power contact (without signal contacts) or combinations of up to 24power Contacts and 40 signal contacts can be used provided the maximum allowable length is not exceeded.
- 5.5. The connector configuration is described by reading left to right on the header.
- 5.6. End modules are available with feature that providing blind mating, alignment, and polarization. End modules contain a guide post (for receptacles only) guide slot (for headers only) and a hold down (for wave soldering application), and/or mounting hole (for press fit application). Guides have rounded edges for ease of mating and positioned to prevent improper mating of connectors. The hold down and mounting hole (which accept commercially available standard screws) help to align the connector to the pc board for installation then secure the connector to the pc board. Convection windows located on the housing provide air flow for power modules.

© 2016 AFCI

NUMBER GS-20-0362	TYPE Application Specification	Amphen	ol FCi
TITLE		PAGE 7 of 22	REVISION C
Application Guide for PwrLoPro H	eaders and Receptacles	AUTHORIZED BY DATE Fancy Zhang 20- Apr-	
			CTED

5.7. The connectors are supplied in tray form for manual placement.

6. APPLICATION REQUIREMENTS

6.1. Safety

Don't stack product shipping containers so high that the containers buckle or deform.

6.2. Limitations

The connectors are designed to operate in a temperature range of -40° to 125°C [-40° to 257°F].

Voltage ratings for these connectors are based upon UL – 60950 -1 Second Edition Tale 2N. Voltage ratings according to Minimum Creep Distance (MCD) are given in Figure 2.

The voltage rating are based on normal circuit pad diameters of 1.12mm for press-fit application

and 1.41mm for solder application and Underwriters Laboratories Inc. (UL), Pollution Group II,

Material Group IIIb. That material group has a comparative tracking index (CTI) of 100≤CTI≤175.

CONTACT			MAX	MUM VOLTAGE RA	TING IN AC (RMS) C	OR DC
TYPE	FUNCTION	PITCH	Within Primary Circuits	Primary to Secondary Circuits	Primary to Ground Circuits	Within Secondary Circuits
	Signal	2.00 [.0787]	—	—	—	60•
Press-Fit Po	Power	2.75 [.1083]	150	150	150	150
		5.50 [.2165]	400	_	400	400
	Signal	2.00 [.0787]	—	—	_	60•
Solder Power	Davina	2.75 [.1083]	100	100	100	100
	5.50 [.2165]	400	_	400	400	

Safety Extra Low Voltage (SELV) Circuits

Figure 2

6.3. Material

The housing is made of glass filled high temperature nylon, UL 94V–0, with an oxygen index of 49%. The contacts are made of high-conductivity copper alloy under plated with nickel and plated with gold or palladium nickel; solder tines are plated with tin over nickel. Retention clips are made of plated copper alloy.

6.4. Storage

6.4.1. Ultraviolet Light

Prolonged exposure to ultraviolet light may deteriorate the chemical composition used in the connector material.

NUMBER GS-20-0362	TYPE Application Specification	Amphen	ol FCi
TITLE Application Guide for PwrLoPro He	eaders and Receptacles	PAGE REVISION 8 of 22 C AUTHORIZED BY DATE Fancy Zhang 20- Apr-2	

6.4.2. Shelf Life

The connectors should remain in the shipping containers until ready for use to prevent deformation to the contacts. The connectors should be used on a first in, first out basis to avoid storage contamination that could adversely affect performance.

6.4.3. Chemical Exposure

Don't store connectors near any chemical listed below as they may cause stress corrosion cracking in the contacts.

Alkalies	Ammonia	Citrates	Phosphates Citrates	Sulfur Compounds
Amines	Carbonates	Nitrites	Sulfur Nitrites	Tartrates

6.5. PC Board

6.5.1. Material and Thickness

The pc board material shall be glass epoxy (FR-4 or G-10). The pc board thickness shall be as stated in Figure 3.

PC BOARD THICKNESS			
CONNECTOR WITH PRESS-FIT CONTACTS	CONNECTOR WITH SOLDER TYPE CONTACTS		
1.40 Min	1.40~2.62mm		

Figure 3

6.5.2. Hole Dimensions, Plating, and Durability

The contact holes must be drilled and plated through to specific dimensions to prevent stubbing during placement of the connector on the pc board and to ensure optimum continuity for circuits after soldering. If applicable, holes for the retention clips or mounting hardware may be used with or without plated through holes. The drilled hole size, plating types, plating thickness, and finished hole size must be as stated to provide unrestricted insertion. See Figure 4.

For connectors with press-fit contacts, the pc board holes can't withstand connector removal more than threes. The radius of any board hole must not increase more than 0.038mm or decrease less than 0.0508mm.

NUMBER GS-20-0362	Application Specification	Amphenol FCi		
TITLE Application Guide for PwrLoPro H	eaders and Receptacles	PAGE REVISION 9 of 22 C AUTHORIZED BY DATE Eancy Zhang 20- Apr-		
			CTED	



	DIMENSION				
APPLICATION	A	_	C (Nominal, Ref)		
	Surface Finish Thickness			в	
	Immersion Gold (Au) Over Nickel (Ni)	0.00127 [.00005] Min	0.71-0.75 [.0280295]	0.65 [.0255]	
	Hot Air Solder Leveling (HASL) Tin (Sn) Tin-Lead (Sn Pb)	0.004-0.015 [.000160006]		0.61 [.0240]	
Press-Fit	Immersion Sn	0.0005 [.00002] Min	0.68-0.72		
	Organic Solderability Preservative (OSP)	0.0002-0.0005 [.00000800002]	[.02670283]		
	Immersion Silver (Ag)	0.0001 [.000004] Min			
	Sn Pb	0.008 [.0003] Min		0.90 [.0354]	
Solder	Immersion Sn	0.0005-0.004 [.000020015]	0.97-1.01		
	Organic Solderability Preservative (OSP)	0.0002-0.0005 [.00000800002]	[.0382-0.398]		
	Immersion Silver (Ag)	0.0001 [.000004] Min			

Figure 4

NUMBER GS-20-0362	Application Specification	Amphen	ol FCi
Application Guide for PwrLoPro Headers and Receptacles		PAGE 10 of 22 AUTHORIZED BY Fancy Zhang	C DATE 20- Apr-2016
			CTED

6.5.3.Land/pad size

The pc board land/pad size is given in Figure 4.

6.5.4. Layout

The holes in the pc board must be precisely located to ensure proper placement and optimum performance of the connector. The pc board layout must be designed using the dimensions provided on the customer drawing for the specific connector. A sample of the recommended pc board layout is shown in Figure 5.



As Viewed from Connector Side

(25S X 10P Plug Assembly Shown)



Figure 5 (Not to Scale)

6.6 Connector Spacing

Care must be used to avoid interference between adjacent connectors and other components.

NUMBER GS-20-0362	TYPE Application Specification	Amphen	ol FCi
TITLE		PAGE 11 of 22	
Application Guide for PwrLoPro Headers and Receptacles Authorized by Fancy Zhang		AUTHORIZED BY Fancy Zhang	^{DATE} 20- Apr-2016
			TED

6.7 Connector Placement

Connectors should be handled only by the housing to avoid deformation, contamination, or damage to the contacts.

6.7.1 Registration

When placing connectors on the pc board, contacts and, if applicable, hold down or mounting screws must be aligned and started into the matching holes before seating the connector onto the pc board.

6.7.2 Insertion force of press fit application

The force required to seat the connector with press-fit contacts or retention clips onto the pc board can be calculated by:

Insertion force N [lbs.] = Number of power contacts X maximum insertion force per power contact N [lbs.] Insertion force N [lbs.] = Number of signal contacts X maximum insertion force per signal contact N [lbs.] Insertion force N [lbs.] = Number of hold downs X maximum insertion force per hold down N [lbs.]

The maximum amount of insertion force per press-fit contact and retention clips is given in Figure 6.

MAXIMUM INSERTION FORCE (N [Ib])				
PER POWER CONTACT PER SIGNAL CONTACT PER BOARD-LOCK (If Applicable				
267 [60]	44.5 [10]	27 [6]		

Figure 6

6.8 Mounting Hardware

Connectors with mounting holes can be secured to the pc board before soldering using commerciallyavailable standard screws. The screw size and maximum torque (applied to the mating face of the connector) is provided in Figure 7.

Typically, this method of mounting (or hold-down) serves connectors with solder type contacts and without hold down. The hardware must be installed BEFORE soldering.

SCREW		MAXIMUM TORQUE	
SIZE HEAD DIAMETER (Maximum)		Nm [inlb] (Applied to Mating Face)	
No. 4	7.37 [.290]	0.57 [5]	

NUMBER GS-20-0362	TYPE Application Specification	Amphenol FC	
TITLE		PAGE 12 of 22	REVISION C
Application Guide for PwrLoPro Headers and Receptacles		AUTHORIZED BY Fancy Zhang	20- Apr-2016
			CTED

6.9 Soldering

Observe guidelines and procedures when soldering contacts. Contact solder tines must be soldered, cleaned, and dried according to the following:

6.9.1 Flux Selection

Contact solder tines must be fluxed prior to soldering with a mildly active, rosin base flux. Selection of the flux will depend on the type of pc board and other components mounted on the board. Additionally, the flux must be compatible with the wave solder line, manufacturing, health, and safety requirements. Flux that is compatible with these connectors are provided in Figure 8.

	ACTIVITY	RESIDUE	COMMERCIA	L DESIGNATION
	ACTIVITY RESIDUE	KESTER	ALPHA	
RMA	Mild	Noncorrosive	186	611

Figure 8

6.9.2 Solder Mask

A solder mask is MUST be applied over the trace of any connector component hanging below the bottom of the pc board to prevent bridging and wicking of solder away from the contact solder tines.

A heat-resistant solder mask is recommended.

If bridging or wicking occurs, the trace must be repaired.

6.9.3 Process

The connectors must be soldered using lead-free wave soldering or equivalent soldering techniques. The temperatures and exposure time shall be as specified in Figure 9.

SOLDERING PROCESS	WAVE TEMPERATURE	TIME (At Maximum Temperature)
Wave	265 °C [509°F]	10 Seconds

Figure 9

6.9.4 Cleaning

NUMBER GS-20-0362	TYPE Application Specification	Amphenol FC	
Application Guide for PwrLoPro Headers and Receptacles		PAGE 13 of 22 AUTHORIZED BY Fancy Zhang	REVISION C DATE 20- Apr-2016
			TED

After soldering, removal of fluxes, residues, and activators is necessary. Consult with the supplier of the solder and flux for recommended cleaning solvents. Cleaners must be free of dissolved flux and other contaminants. Common cleaning solvents that will not the affect connectors for the time and temperature specified are list in Figure 10.

Consideration must be given to toxicity and other safety requirements recommended by the solvent manufacturer. Refer to the manufacture's Material Safety Data Sheet (MSDS) for characteristics and handling of cleaners. Trichloroethylene and Methylene Chloride is not recommended because of harmful occupational and environmental effects. Both are carcinogenic (cancer-causing).

Even when using "no clean" solder paste, it is imperative that the contact interface be kept clean of flux and residue, since it acts as an insulator. Flux may migrate under certain conditions with elevated temperatures and therefore, cleaning is necessary.

The cleaning process must be accomplished by hand.

CLEANER		TIME	TEMPERATURE (Maximum)	
NAME	NAME TYPE ^{(N}		132 °C [270°F]	
ALPHA 2110	Aqueous	1	100 °C [212°F]	
BIOACT EC-7	Solvent	5	100 °C [212°F]	
BIOACT EC-7	Solvent	5	Ambient Room	
Butyl CARBITOL	Solvent	1	100 ° C[212°F]	
Isopropyl Alcohol	Solvent	5	100 °C [212°F]	
KESTER 5778	Aqueous	5	100 ° C[212°F]	
KESTER 5779	Aqueous	5	100 °C [212°F]	
LONCOTERGE 520	Aqueous	5	100 °C [212°F]	
LONCOTERGE 530	Aqueous	5	100 °C [212°F]	
Terpense Solvent	Solvent	5	100 ° C[212°F]	

Lubricant at the mating interface MUST NOT be removed.

Figure 10

(ALPHA is a trademark of Alpha Metals, Inc. CARBITOL is a trademarks of Union Carbide Corporation

BIOACT is a trademark of Petroferm, Inc.

KESTER is a trademark of Kester, Inc.

LONCOTERGE is a trademark of London Chemical Company, Inc.)

6.9.5 Drying

When drying cleaned connectors and pc boards, make certain that temperature limitations are not exceeded: -40°C to 125°C [-104°F to 257°F]. Excessive temperatures may cause housing degradation.

6.10 Checking Installed Connector

NUMBER GS-20-0362	TYPE Application Specification	Amphenol FC	
TITLE		PAGE 14 of 22	
pplication Guide for PwrLoPro Headers and Receptacles AUTHORIZED BY D/ Fancy Zhang 2		20- Apr-2016	
			CTED

6.10.1 Using contacts for press-fit application

The entire "eye" of each contact must be within the pc board hole. The housing must be seated on the pc board within the dimension provided in Figure 11, Detail A.

6.10.2 Using contacts for soldering application

Solder fillets must be evenly formed around each contact solder tail. There must be no visible skips or void. The housing must be seated on the pc board within the dimension provided in Figure 11, Detail B.



Figure 11

6.11 Connector Mating

NUMBER GS-20-0362	Application Specification	Amphenol FC	
		PAGE 15 of 22	REVISION C
Application Guide for PwrLoPro Headers and Receptacles		AUTHORIZED BY Fancy Zhang	20- Apr-2016
			TED

Connectors should be handled only by the housing to avoid deformation, contamination, or damage to the contacts.

6.11.1 Polarization

For connectors with guides, polarization is provided by matching the guide posts of the receptacle with the guide slots of the header. For connectors with latch receivers or without guides, polarization is provided by matching the mating alignment keys with the key slots of mating connectors.

6.11.2 Mating Force

The maximum amount of mating force per contact is given in Figure 12.

CONTACT	MAXIMUM MATING FORCE PER CONTACT (N [oz])
Power	3.00 [10.8]
Signal	1.65 [5.9]

Figure 12

6.11.3 Mating Length

Contact mating lengths available for the connectors are listed in Figure 13.

NUMBER GS-20-0362	TYPE Application Specification	Amphenol FC	
Application Guide for PwrLoPro Headers and Receptacles		PAGE 16 of 22 AUTHORIZED BY Fancy Zhang	C DATE 20- Apr-2016
			CTED

Mating Length

Signal Contacts

Mating Level 2^*



Power Contacts



* The offset distance between Mating Level 2 for power contacts and Mating Level 2 for signal contacts is not

enough to consider these as separate levels.









CONTACT TYPE	MATING LENGTH	MATING LEVEL
Dowor	MFBL (Pre-Mate)	1
Power	Standard	2
Signal	Standard	2
Signal	MLBF (Post-Mate)	3

Figure 13

NUMBER GS-20-0362	TYPE Application Specification	Amphenol FC	
TITLE		PAGE 17 of 22	REVISION C
Application Guide for PwrLoPro Headers and Receptacles		AUTHORIZED BY Fancy Zhang	20- Apr-2016
			TED

6.11.4 Mating distance and wipe length

The connectors provide sequencing among contacts with 3 mating levels. The mating distance, measured from the receptacle mating face to the header mating face at the point of electrical engagement, depends on the contact (power or signal) and mating length (standard, MFBL, or MLBF) of the mating connectors.

Wiping length for these connectors is defined as that portion (length) of the mating contacts that touches (wipes) from the point of engagement to the point of being fully mated. The wipe length depends on the contact (power or signal) and mating length (standard, MFBL, or MLBF) of each *individual* contact.

The mating distance and minimum wipe length at the mating level for power and signal contacts is listed in Figure 14.



00117407			MATING DISTANCE			WIPE LENGTH
CONTACT	MATING LENGTH	DIMENSION		First Mate	Reliable Mate	(Min)
Power	MFBL (Pre-Mate)	1	А	8.52 [.3354]	6.68 [.263]	6 [.235]
	Standard	2	В	6.92 [.2724]	5.08 [.200]	4.4 [.173]
Signal	Standard	2	С	5.42 [.2134]	5.01 [.197]	3.75 [.148]
	MLBF (Post Mate)	3	D	3.92 [.1543]	3.51 [.138]	2.25 [.089]

Figure 14

6.11.5 Misalignment

NUMBER GS-20-0362	Application Specification	Amphenol FC	
TITLE Application Guide for PwrLoPro H	eaders and Receptacles	PAGE 18 of 22 AUTHORIZED BY Fancy Zhang	C DATE 20- Apr-2016
		CLASSIFICATION UNRESTR	

When mating connectors, side-to-side and up-and-down misalignment is allowed to the dimensions given in Figure 15.





6.11.6 Mating dimension

When fully engaged, the dimension between the first contact of the receptacle and the first contact of the header meet the dimension given in Figure 16.





NUMBER GS-20-0362	TYPE Application Specification	Amphen	ol FCi
TITLE Application Guide for PwrLoPro H	eaders and Receptacles	PAGE REVISION 19 of 22 C AUTHORIZED BY DATE Fancy Zhang 20- Apr-2	
			ICTED

The connectors can withstand 250 mating cycles.

6.12 Circuit Testing

Unmated receptacles and mated headers must be tested against hazardous voltages using the test probe specified in UL 1950. Specific area of the connector must be tested as indicated in Figure 17.









6.13 Connector Removal

NUMBER GS-20-0362	TYPE Application Specification	Amphenol FC	
TITLE	adara and Decentralias	PAGE 20 of 22	
Application Guide for PwrLoPro Headers and Receptacles		Fancy Zhang	20- Apr-2016
			TED

6.13.1 Solder Type Contacts

These connectors must be removed from the pc board by standard de-soldering methods. After removal from the board, the connector MUST NOT be re-used.

6.13.2 Press-Fit Contacts

These connectors must be removed from the pc board using a push bar (or flat rock) and pc board support.

(For repairability, the tips of the contacts must extend below the surface of the pc board by at least 1.02 [.040]; If not, the connector MUST NOT be removed from the pc board.)

6.14 Repair

These connectors are not repairable. Damaged or defective connectors must not be used.

7. Qualification

PowLoPro connectors are Recognized by Underwriters Laboratories (UL) in File E66906.

- 8. Tooling
- 8.1 Connectors used for Press-Fit application

Tooling needed to seat connectors with press-fit contacts are shown in Figure 18.

8.1.1 Application Tooling

The application tooling (such as an arbor press) used to seat these connectors must provide sufficient amount of downward force to insert the contacts into the pc board holes.

8.1.2 PC Board Support

A pc board support must be used to prevent bowing of the pc board during the placement of these connectors on the board. The board support must have a flat surface with holes or a channel large enough and deep enough to receive any protruding components. The pc board must be secured to the board support to prevent movement of the board during seating.

The board support must also be used when removing these connectors from the pc board.

8.1.3 Flat Rock Tooling

Commercially available bar stock (flat rock tooling) with a flat surface large enough to cover all contacts must be used with the application tooling to seat and remove these connectors.

For removing these connectors from the pc board, it is suggested that the pc board be supported from the connector side and that the connector be removed using flat rock tooling.

NUMBER	TYPE		
GS-20-0362	Application Specification	Ampher	ol FCi
TITLE		PAGE	REVISION
		21 of 22	С
Application Guide for PwrLoPro H	eaders and Receptacles	AUTHORIZED BY	DATE
		Fancy Zhang	20- Apr-2016
			ICTED



Figure 18

9. Visual Aid

The illustration below shows a typical application of PwrLoPro connectors. This illustration should be used by production personnel to ensure a correctly applied product. Application which DO NOT appear correct should be inspected using the information in the preceding pages of this specification and in the instructional material shipped with the product or tooling. See Figure 19.



Figure 19

NUMBER GS-20-0362	Application Specification	Ampher	nol FCi
TITLE Application Guide for PwrLoPro H	eaders and Receptacles	PAGE 22 of 22 AUTHORIZED BY Fancy Zhang	REVISION C DATE 20- Apr-2016
			RICTED

Record Retention

REV	PAGE	DESCRIPTION	EC #	DATE
A	ALL	Rev A Initial		21-Dec-2012
В	ALL	Released to unrestricted classification	ECN-ELX-DG-15580	22-Aug-2013
С	ALL	Correct the insertion force of signal EON	ECN-ELX-DG-23900	20-Apr-2016